



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Larry D. Kinsman

Serial No.: 10/792,229

Filed: March 3, 2004

For: BUMPED DIE AND WIRE BONDED
BOARD-ON-CHIP PACKAGE

Confirmation No.: 4782

Examiner: T. Ho

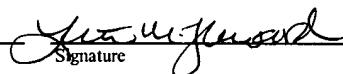
Group Art Unit: 2818

Attorney Docket No.: 2269-4585.3US
(00-0658.03/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

January 18, 2006
Date


Signature

Leta M. Howard
Name (Type/Print)

AMENDMENT

Mail Stop Amendment
Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Sir:

The following amendments and remarks are filed in response to the Examiner's remarks in the Office Action mailed October 18, 2005, the three-month shortened statutory period for response to which expires on January 18, 2006.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks begin on page 9 of this paper.